# Power MOSFET, N-Channel, SUPERFET<sup>®</sup> III, Easy-Drive, 650 V, 24 A, 125 m $\Omega$

#### **General Description**

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET Easy-drive series helps manage EMI issues and allows for easier design implementation.

The Power88 package is an ultra-slim surface-mount package (1 mm high) with a low profile and small footprint ( $8 \times 8 \text{ mm}^2$ ). SUPERFET III MOSFET in a Power88 package offers excellent switching performance due to lower parasitic source inductance and separated power and drive sources. Power88 offers Moisture Sensitivity Level 1 (MSL 1).

#### Features

- 700 V @  $T_J = 150^{\circ}C$
- Typ  $R_{DS(on)} = 100 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 49 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 406 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

#### Applications

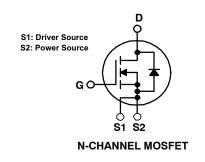
- Telecom / Server Power Supplies
- Industrial Power Supplies
- UPS / Solar



# **ON Semiconductor®**

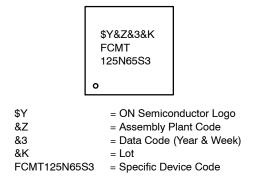
#### www.onsemi.com

V <sub>DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX	
650 V	125 mΩ @ 10 V	24 A	





#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter		Value	Unit V
V <sub>DSS</sub>	Drain to Source Voltage		650	
V <sub>GSS</sub>	Gate to Source Voltage	DC	±30	V
		AC (f > 1 Hz)	±30	V
Ι <sub>D</sub>	Drain Current	Continuous (T <sub>C</sub> = 25°C)	24	А
		Continuous (T <sub>C</sub> = 100°C)	15	
I <sub>DM</sub>	Drain Current	Pulsed (Note 1)	60	А
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		115	mJ
I <sub>AS</sub>	Avalanche Current (Note 2)		3.7	А
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		1.81	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		20	
P <sub>D</sub>	Power Dissipation	(T <sub>C</sub> = 25°C)	181	W
		Derate Above 25°C	1.45	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 s		300	°C

#### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C, Unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2.  $I_{AS} = 3.7 \text{ A}, R_G = 25 \Omega \text{ starting } T_J = 25^{\circ}\text{C}$ 3.  $I_{SD} \le 12 \text{ A}, \text{ di/dt} \le 200 \text{ A/}\mu\text{s}, \text{V}_{DD} \le 400 \text{ V}, \text{ starting } T_J = 25^{\circ}\text{C}$ 

#### THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{\thetaJC}$	Thermal Resistance, Junction to Case, Max.	0.69	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient, Max. (Note 4)	45	

4. Device on 1 in<sup>2</sup> pad 2 oz copper pad on  $1.5 \times 1.5$  in. board of FR-4 material.

#### **ORDERING INFORMATION**

Device Marking		Package Reel Size Tape Widt		Tape Width	Quantity <sup>†</sup>	
FCMT125N65S3 FCMT125N65S		Power 88	13″	13.3 mm	3000 Units	

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARACT	ERISTICS					-
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 25°C	650	-	_	V
		$V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 150 $^\circ C$	700	-	_	V
$\Delta \text{BV}_{\text{DSS}}\!/\!\Delta\text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D$ = 1 mA, Referenced to 25°C	-	0.68	-	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS}$ = 650 V, $V_{GS}$ = 0 V	-	-	1	μA
		$V_{DS}$ = 520 V, $T_C$ = 125°C	-	1.35	_	
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS}$ = ±30 V, $V_{DS}$ = 0 V	-	-	±100	nA
N CHARACTE	RISTICS					-
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 0.59$ mA	2.5	-	4.5	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS}$ = 10 V, I <sub>D</sub> = 12 A	-	100	125	mΩ
9fs	Forward Transconductance	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 12 \text{ A}$	-	16	-	S
YNAMIC CHA	RACTERISTICS					
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 400 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	1920	-	pF
Coss	Output Capacitance		-	44	-	pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V	-	406	-	pF
C <sub>oss(er.)</sub>	Energy Related Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V	-	63	_	pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10V		-	49	_	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	$V_{DS}$ = 400 V, I <sub>D</sub> = 12 A, V <sub>GS</sub> = 10 V (Note 5)	-	12	_	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		-	22	_	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	0.5	_	Ω
WITCHING CH	IARACTERISTICS					-
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD}$ = 400 V, I <sub>D</sub> = 12 A, V <sub>GS</sub> = 10 V, R <sub>g</sub> = 4.7 Ω (Note 5)	-	22	-	ns
t <sub>r</sub>	Turn-On Rise Time		-	22	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	60	_	ns
t <sub>f</sub>	Turn-Off Fall Time		-	5.8	_	ns
OURCE-DRAI	N DIODE CHARACTERISTICS					
۱ <sub>S</sub>	Maximum Continuous Source to Drain Diode Forward Current		-	-	24	Α
I <sub>SM</sub>	Maximum Pulsed Source to Drain Diode Forward Current		-	-	60	Α
$V_{SD}$	Source to Drain Diode Forward Voltage	$V_{GS}$ = 0 V, $I_{SD}$ = 12 A	-	-	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 12 A, dI <sub>F</sub> /dt = 100 A/μs	-	345	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	5.7	_	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 5. Essentially independent of operating temperature typical characteristics.

### **TYPICAL PERFORMANCE CHARACTERISTICS**

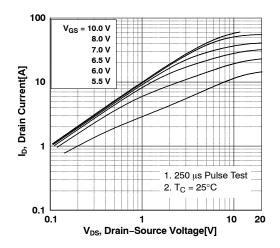


Figure 1. On-Region Characteristics

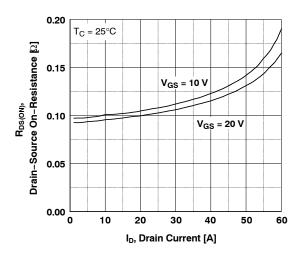


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

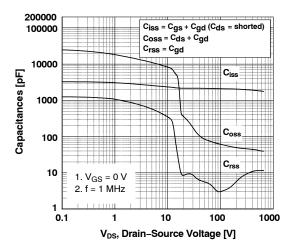
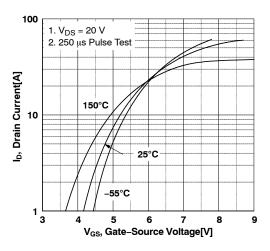


Figure 5. Capacitance Characteristics



**Figure 2. Transfer Characteristics** 

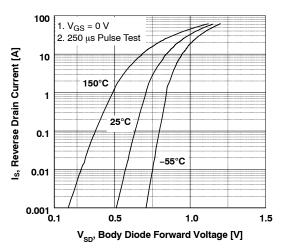


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

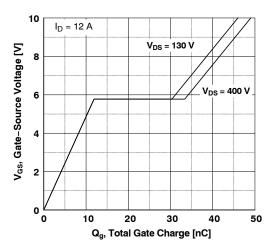
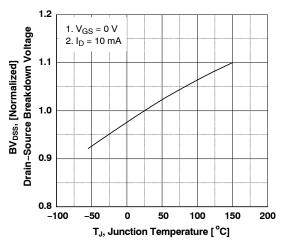


Figure 6. Gate Charge Characteristics

# TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





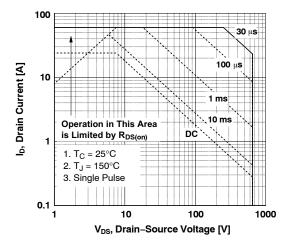


Figure 9. Maximum Safe Operation Area

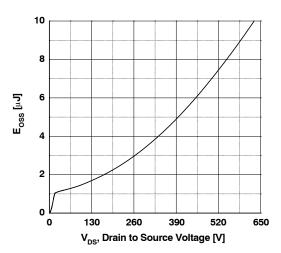


Figure 11. E<sub>OSS</sub> vs. Drain to Source Voltage

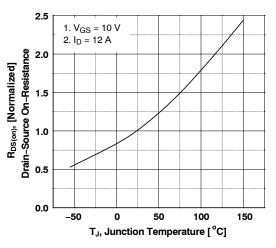


Figure 8. On-Resistance Variant vs. Temperature

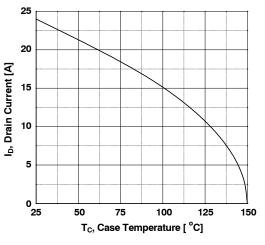


Figure 10. Maximum Drain Current vs. Case Temperature

# TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

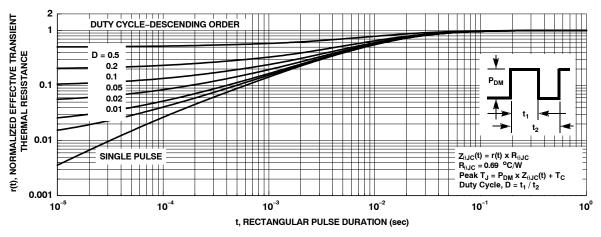
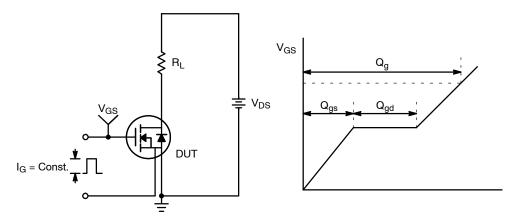


Figure 12. Transient Thermal Response Curve





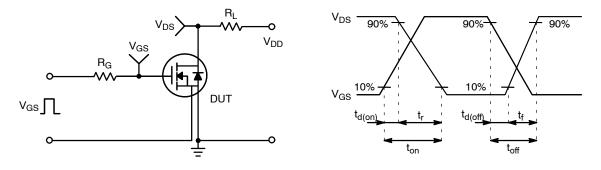


Figure 14. Resistive Switching Test Circuit & Waveforms

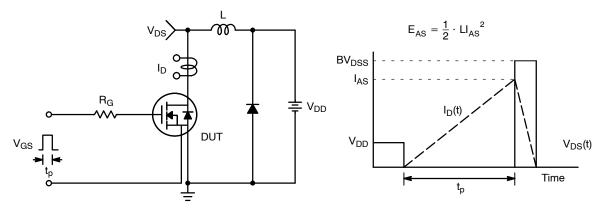


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

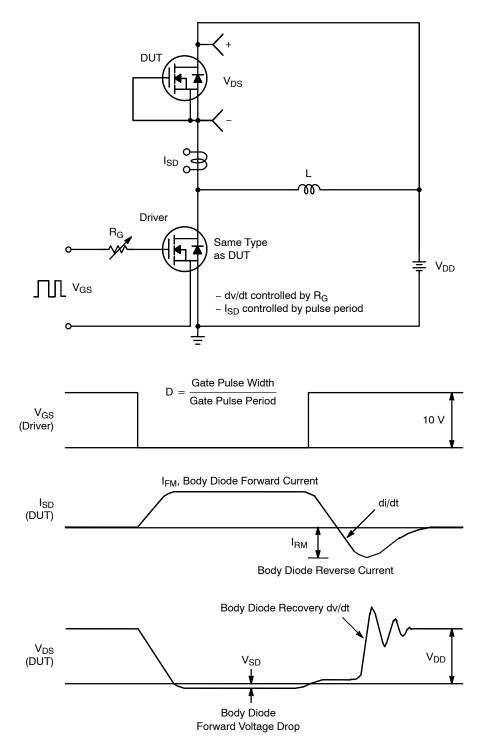
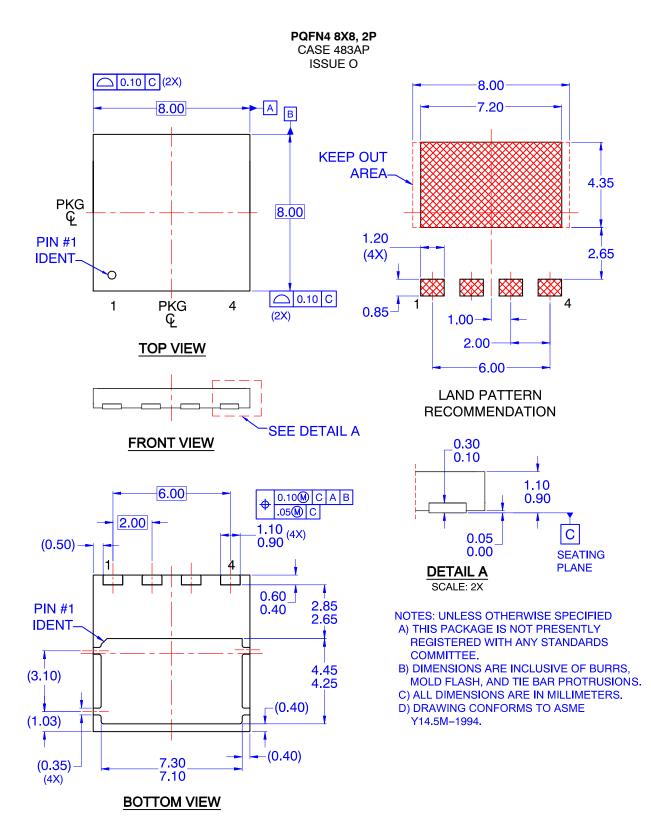


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

#### PACKAGE DIMENSIONS



#### SUPERFET is a registered trademark of Semiconductor Components Industries, LLC.

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all aws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor date sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights or the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor handles, and expenses, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associate

Phone: 421 33 790 2910

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative